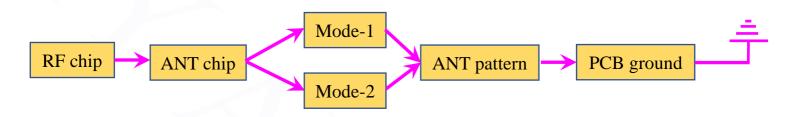
- 深圳市宝安区前进二路宝运达物流信息大厦12A10/12A11
 - 青岛市崂山区松岭路399号海信产业园A1号楼606 Address: 606, Building A1, Hisense Industrial Park, No. 399 Songling Road, Laoshan District, Qingdao City 电话: 0755-23069700 传真: 0755-23069700

✓ Features:

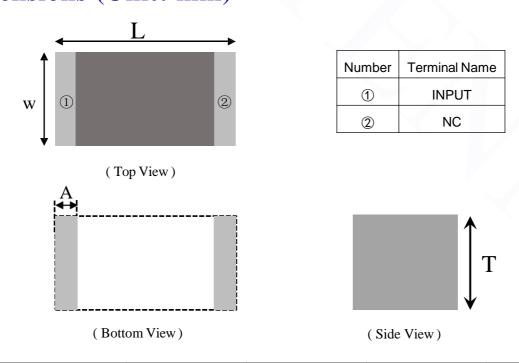
- 1. Surface mounted element with a small dimension of $1.6 \times 0.8 \times 0.8$ mm meet future miniaturization trend.
- 2. Embedded and LTCC (low temperature co-fired ceramic) technology is able to integrate with system design as well as beatifying the housing of final product.
- 3. Miniaturization, wideband, high stability, low ESR, and low tolerance.
- 4. Dual-band resonances in the dominant and harmonic modes enables multiband operations.
- 5. Novel ground-radiation technique enables radiation from both the antenna and the ground plane.



✓ Applications:

- 1. Bluetooth
- 2. Dual-band WLAN
- 3. ISM and UWB

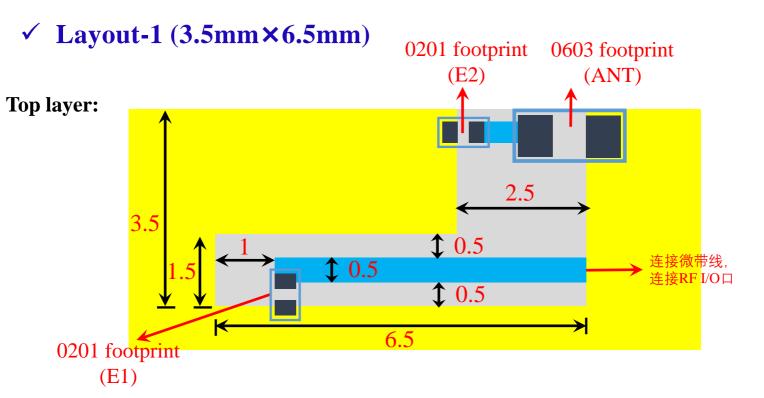
✓ Dimensions (Unit: mm)

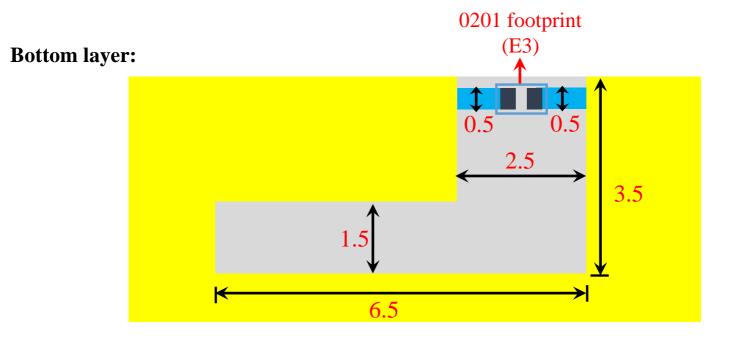


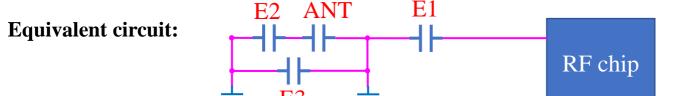
Symbols	L	W	T	A	
Dimensions	1.60 ± 0.20	0.80 ± 0.20	0.80 ± 0.20	0.30 ± 0.10	



- 深圳市宝安区前进二路宝运达物流信息大厦12A10/12A11
- 青岛市崂山区松岭路399号海信产业园A1号楼606 Address: 606, Building A1, Hisense Industrial Park, No. 399 Songling Road, Laoshan District, Qingdao City 电话: 0755-23069700 传真: 0755-23069700





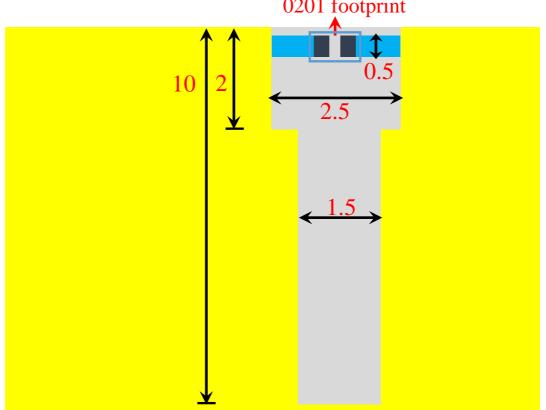




- 深圳市宝安区前进二路宝运达物流信息大厦12A10/12A11
- 岛市崂山区松岭路399号海信产业园A1号楼606 Address: 606, Building A1, Hisense Industrial Park, No. 399 Songling Road, Laoshan District, Qingdao City 电话: 0755-23069700 传真: 0755-23069700

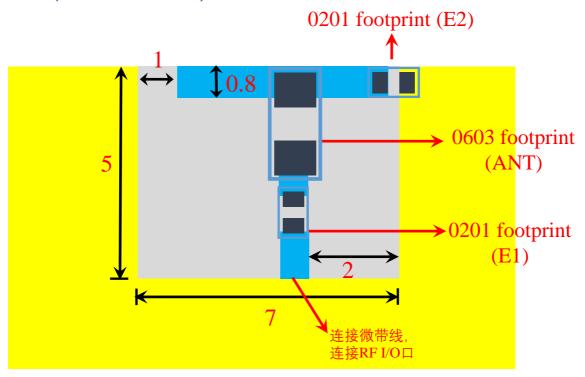
0603 0201 Layout-2 $(1.5 \text{mm} \times 10 \text{mm})$ footprint footprint Top layer: 0.5 0201 footprint 0201 footprint

Bottom layer:

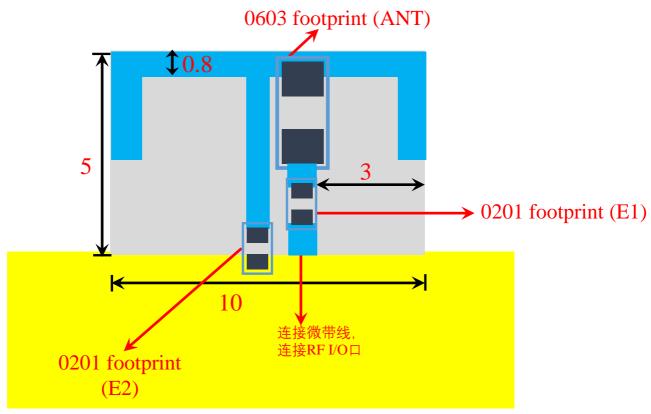


- 深圳市宝安区前进二路宝运达物流信息大厦12A10/12A11
- 青岛市崂山区松岭路399号海信产业园A1号楼606 Address: 606, Building A1, Hisense Industrial Park, No. 399 Songling Road, Laoshan District, Qingdao City 电话: 0755-23069700 传真: 0755-23069700

\checkmark Layout-3 (5mm×7mm)



✓ Layout-4 (5mm×10mm)



■ 深圳市宝安区前进二路宝运达物流信息大厦12A10/12A11

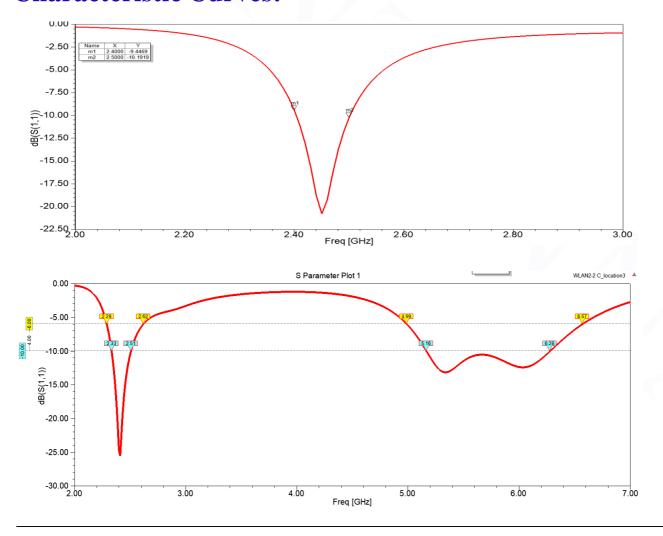
青岛市崂山区松岭路399号海信产业园A1号楼606 Address: 606, Building A1, Hisense Industrial Park, No. 399 Songling Road, Laoshan District, Qingdao City

电话: 0755-23069700 传真: 0755-23069700

✓ Electrical Characteristics:

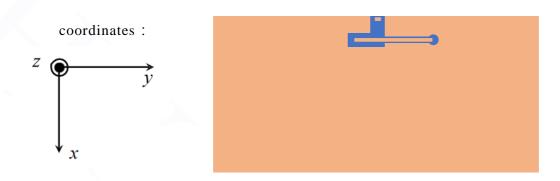
	Feature	Specification		
1	Central frequency	2.45GHz&5.5GHz		
2	Bandwidth	>150MHz		
3	Peak gain	2~3dBi		
4	VSWR	<2		
5	Polarization	Linear		
6	Azimuth beamwidth	Omnidirectional		
7	Impedance	50 Ω		

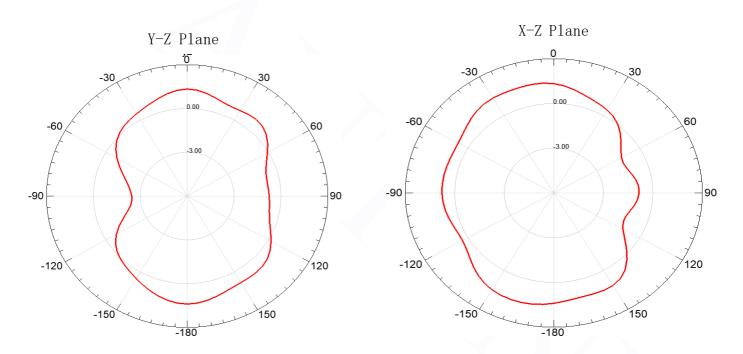
✓ Characteristic Curves:



- 深圳市宝安区前进二路宝运达物流信息大厦12A10/12A11
 - 青岛市崂山区松岭路399号海信产业园A1号楼606 Address:606, Building A1, Hisense Industrial Park, No. 399 Songling Road, Laoshan District, Qingdao City 电话:0755-23069700 传真:0755-23069700

Radiation Pattern:





✓ Radiation Performance:

Frequency	2450MHz	5500MHz
Avg. gain	-0.85	-1.30
Peak gain	3.0	3.5
Efficiency	82%	78%

■ 深圳市宝安区前进二路宝运达物流信息大厦12A10/12A11

青岛市崂山区松岭路399号海信产业园A1号楼606 Address:606, Building A1, Hisense Industrial Park, No. 399 Songling Road, Laoshan District, Qingdao City

电话: 0755-23069700 传真: 0755-23069700

✓ Dependability Test

Test Temperature $25^{\circ}\text{C} \pm 5^{\circ}\text{C}$ Operating Temperature $-25^{\circ}\text{C} \sim +125^{\circ}\text{C}$ Temperature $5\sim 40^{\circ}\text{C}$ Relative Humidity $20\sim 70\%$

✓ Moisture Proof

Temperature: 40±2°C Humidity: 90~95%RH

Duration: 500h

Recovery conditions: Room temperature Recovery Time: 24h (Class1) or 48h (Class2)

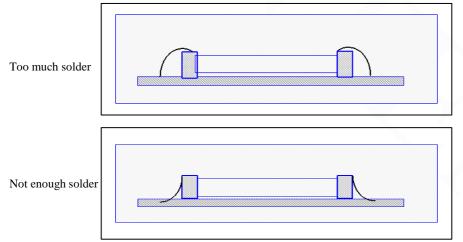
✓ Solderability

At least 95% of the terminal electrode is covered by new solder.

Preheating conditions:80 to 120°C; 10~30s.

Solder Temperature: 235 ± 5°C Duration: 2 ±0.5s, Solder Temperature: 245 ± 5°C Duration: 2 ±0.5s

✓ Optimum Solder Amount for Reflow Soldering

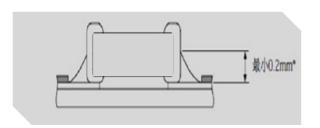


Cracks tend to occur due to large stress.

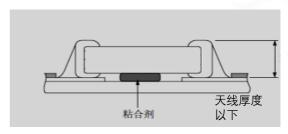
Weak holding force may cause bad connection between the chip and PCB.

✓ Recommended Soldering Amounts

The optimal solder fillet amounts for re-flow soldering



The optimal solder fillet amounts for wave soldering



■ 深圳市宝安区前进二路宝运达物流信息大厦12A10/12A11

青岛市崂山区松岭路399号海信产业园A1号楼60 Address: 606, Building A1, Hisense Industrial Park, No. 399 Songling Road, Laoshan District, Qingdao City

电话: 0755-23069700 传真: 0755-23069700

✓ Temperature Cycle Test

 10 ± 1 S Applied Force: 5N Duration: 10 ± 1 S Preheating conditions: up-category temperature, 1h

Recovery time: 24±1h Initial Measurement

Cycling Times: 5 times, 1 cycle, 4 steps:

阶段	温度(℃)	时间(分钟)
第1步	下限温度(NPO/X7R/X7S/X6S/X5R:-55)	30
第2步	常温 (+20)	2~3
第3步	上限温度(NPO/X7R/X78:+125 YSV/ZSU/X5R:+85 X68:+105)	30
第4步	常温 (+20)	2~3

✓ Resistance to Soldering Heat

Preheating 80 to 120°C; 10~30s.SolderTemperature: 235±5°C; Duration: 2±0.5s; SolderTemperature: 245±5°C

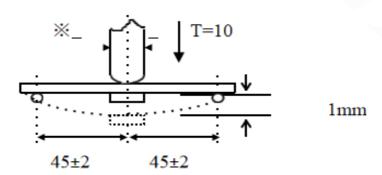
Duration: 2±0.5s; Preheating 100 to 200°C; 10±2min. Solder Temperature: 265±5°C; Duration: 10±1s

Clean the capacitor with solvent and examine it with a 10X(min.) microscope.

Recovery Time: 24±2h

Recovery condition: Room temperature

✓ Resistance to Flexure of Substrate



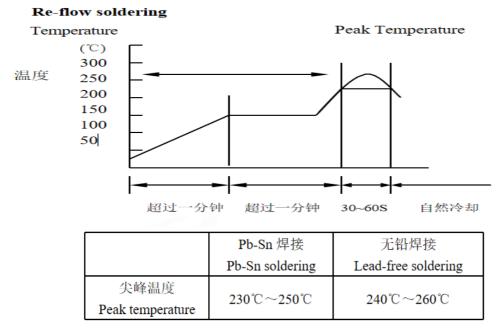
Test Board: Al₂O₃ or PCB Warp: 1mm Speed: 0.5mm/sec.

Unit: mm

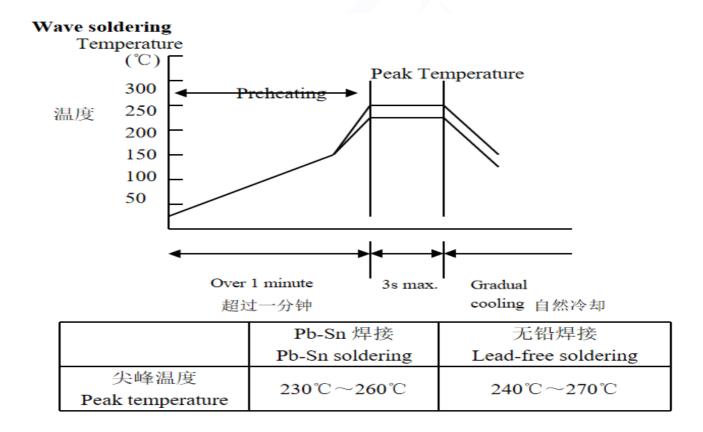
The measurement should be made with the board in the bending position.

- 深圳市宝安区前进二路宝运达物流信息大厦12A10/12A11
- 青岛市崂山区松岭路399号海信产业园A1号楼606 Address: 606, Building A1, Hisense Industrial Park, No. 399 Songling Road, Laoshan District, Qingdao City 电话: 0755-23069700 传真: 0755-23069700

The temperature profile for soldering

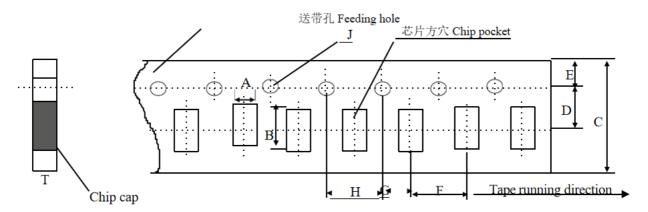


While in preheating, please keep the temperature difference between soldering temperature and surface temperature of chips as: $T \le 150$ °C.



- 深圳市宝安区前进二路宝运达物流信息大厦12A10/12A11
 - 青岛市崂山区松岭路399号海信产业园A1号楼606 Address: 606, Building A1, Hisense Industrial Park, No. 399 Songling Road, Laoshan District, Qingdao City 电话: 0755-23069700 传真: 0755-23069700

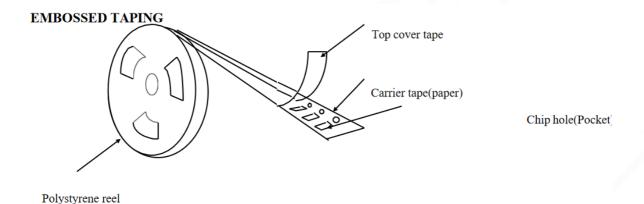
Dimensions of paper taping



Unit: mm

代号Code 纸带规格 papersize	A	В	С	D*	E	F	G*	Н	J	T
尺寸	1.10	1.90	8.00	3.50	1.75	4.00	2.00	4.00	1.50	1.10
	±0.10	±0.10	±0.10	±0.05	±0.10	±0.10	±0.10	±0.10	-0/+0.10	Max

Reel (4000 pcs/Reel)



✓ Storage Period

The guaranteed period for solderability is 6 months (Under deliver package condition). Temperature:5~40°C /Relative Humidity:20~70%